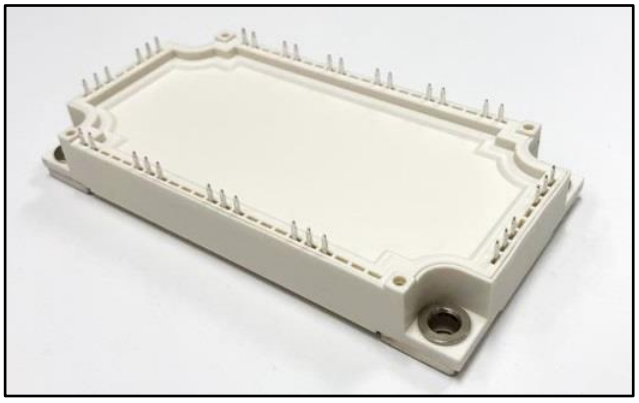
JG1H150S120DG2

Features

- Low $V_{CE(sat)}$
- Fast Switching
- High Ruggedness
- Short-Circuit Rated

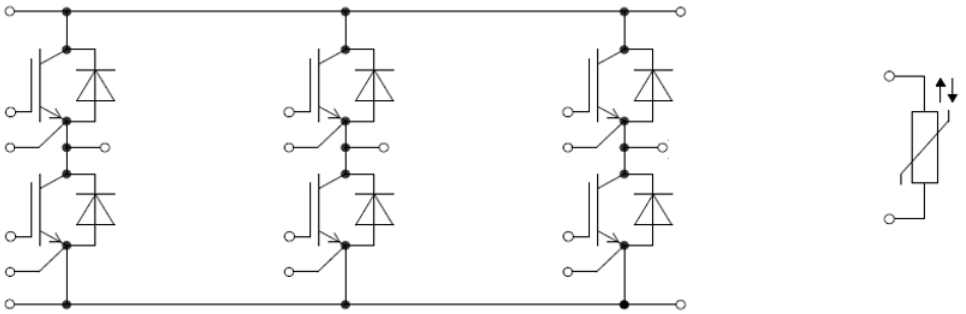
Product Summary	
V_{CES}	1200V
I_C	150A
$V_{CE(sat),typ}$	1.6V



Applications

- General Purpose Inverters
- Frequency Converters
- Industrial Motor Drives
- Uninterruptible Power Supply (UPS)
- Servos

Internal Connection



• IGBT, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Collector-to-Emitter Voltage	V_{CES}	1200	V
Gate-to-Emitter Voltage	V_{GES}	±20	
Transient Gate-emitter Voltage ($t_p \leq 10\mu s$, D < 0.010)		±30	
Continuous DC Collector Current (T_C = 100 °C, T_J = 175°C)	I_{CDC}	150	A
Repetitive Peak Collector Current (t_p = 1ms)	I_{CRM}	300	
Maximum Power Dissipation (T_C = 25°C, T_J = 175°C)	$P_{D(max)}$	735	W

Electrical Characteristics (1), (2)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector-to-Emitter Breakdown Voltage	BV_{CES}	V_{GE} = 0V, I_C = 250μA	1200	-	-	V
Collector-to-Emitter Leakage Current	I_{CES}	V_{CE} = 1200V, V_{GE} = 0V	-	-	5	mA
Gate-to-Emitter Leakage Current	I_{GES}	V_{CE} = 0V, V_{GE} = ±20V	-	-	400	nA
Gate Threshold Voltage	$V_{GE(th)}$	V_{CE} = V_{GE} , I_C = 1.5mA	4.8	6	7.2	V
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	V_{GE} = 15V, I_C = 150A	-	1.6	2.0	
		V_{GE} = 15V, I_C = 150A, T_J = 150°C	-	1.95	-	
		V_{GE} = 15V, I_C =150A, T_J =175°C	-	2.05	-	
Total Gate Charge	Q_g	V_{CC} = 600V, V_{GE} = ±15V, I_C = 150A	-	1.44	-	μC
Internal Gate Resistance	R_{Gint}	-	-	3	-	Ω
Input Capacitance	C_{iss}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz	-	9.73	-	nF
Output Capacitance	C_{oss}		-	0.68	-	
Reverse Transfer Capacitance	C_{rss}		-	0.13	-	
Turn-on Delay time	$t_{d(ON)}$	V_{CC} = 600V, V_{GE} = ±15V, R_G = 5.1Ω, I_C = 150A, L_{load} = 0.82mH, Energy losses include “tail” and diode reverse recovery.	-	358	-	ns
Rise Time	t_r		-	48	-	
Turn-off Delay time	$t_{d(OFF)}$		-	452	-	
Fall Time	t_f		-	154	-	
Turn-On Switching Loss	E_{on}		-	8.5	-	mJ
Turn-Off Switching Loss	E_{off}		-	10.0	-	
IGBT Total Switching Loss	E_{ts}		-	18.5	-	
Turn-on Delay time	$t_{d(ON)}$	V_{CC} = 600V, V_{GE} = ±15V, R_G = 5.1Ω, I_C = 150A, L_{load} = 0.82mH, Energy losses include “tail” and diode reverse recovery. T_J = 150°C	-	632	-	ns
Rise Time	t_r		-	60	-	
Turn-off Delay time	$t_{d(OFF)}$		-	470	-	
Fall Time	t_f		-	278	-	
Turn-On Switching Loss	E_{on}		-	14.2	-	mJ
Turn-Off Switching Loss	E_{off}		-	16.8	-	
IGBT Total Switching Loss	E_{ts}		-	31	-	
Short Circuit Collector Current	$I_{C(SC)}$	V_{GE} = 15V, V_{CC} ≤ 600V, t_{SC} ≤ 10μs	-	600	-	A

• Diode, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	1200	V
Continuous DC Forward Current	I_F	150	A
Repetitive Peak Forward Current (t_P = 1ms)	I_{FRM}	300	

Electrical Characteristics (1)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	V_F	I_F = 150A	-	2.0	2.4	V
		I_F = 150A T_J = 150°C	-	1.8	-	
		I_F = 150A T_J = 175°C	-	1.75	-	
Diode Reverse-Recovery Charge	Q_{rr}	V_R = 600V, I_F = 150A, dI_F/dt = -1690 A/µs	-	10.66	-	µC
Diode Peak Reverse-Recovery Current	I_{rrm}		-	99	-	A
Diode Reverse-Recovery Loss	E_{rr}		-	3.35	-	mJ

• NTC thermistors

Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Rated Resistance	R_{25}	-	-	5.0	-	kΩ
Deviation of R100	ΔR/R	T_C =100°C R_{100} = 493Ω	-5	-	5	%
Power Dissipation	P_{25}	-	-	-	20.0	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15\ K))]$	-	3375	-	K

• Module

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Maximum Junction Temperature	T_j	-40 to +175	°C
Operating Junction Temperature	$T_{vj\ op}$	-40 to +150	
Storage Temperature	T_{stg}	-40 to +125	
Isolation Voltage (RMS, f = 50 Hz, t = 1 min)	V_{ISO}	2.5	kV

Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Material of Module Baseplate	-	-	Cu	-	-
Internal Isolation	-	-	Al_2O_3	-	-
Creepage Distance, Terminal to Terminal	-	-	10	-	mm
Clearance, Terminal to Terminal	-	-	7.5	-	mm
Stray Inductance, Module	L_{SCE}	-	21	-	nH
Module Lead Resistance, Terminal to Chip	$R_{CC'+EE'}$	-	1.8	-	mΩ
Junction-to-Case Thermal Resistance, per IGBT, Inverter	$R_{\theta JC}$	-	0.17	-	°C/W
Junction-to-Case Thermal Resistance, per Diode, Inverter		-	0.26	-	
Case-to-Heatsink Thermal Resistance, per IGBT, Inverter	$R_{\theta CH}$	-	0.09	-	°C/W
Case-to-Heatsink Thermal Resistance, per Diode, Inverter		-	0.16	-	
Case-to-Heatsink Thermal Resistance, per Module		-	0.01	-	
Mounting Torque for Module Mounting, Screw M5	M	3.0	-	6.0	Nm
Weight per Module	G	-	300	-	g

(1) T_J = 25°C unless otherwise specified

(2) t_r: from 10% of I_C to 90% of I_C; t_f: from 90% of I_C to 10% of I_C;

E_{on}: from 10% of V_{GE} to 10% of V_{CE}; E_{off}: from 90% of V_{GE} to 10% of I_C.

• Typical Electrical Characteristics

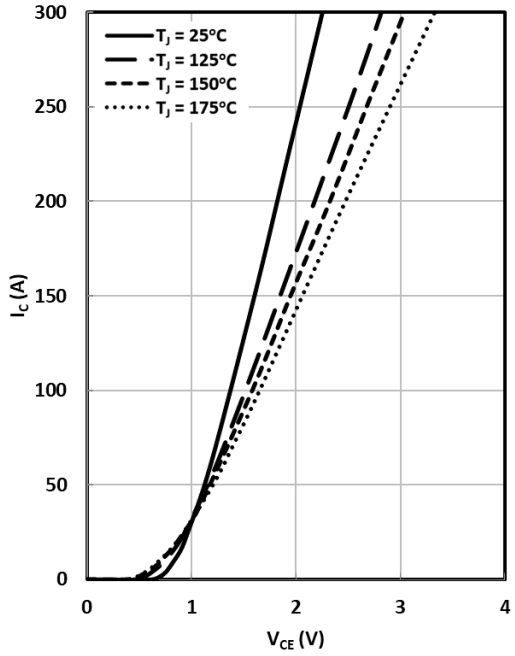


Fig. 1 IGBT (Inverter) Output Characteristics

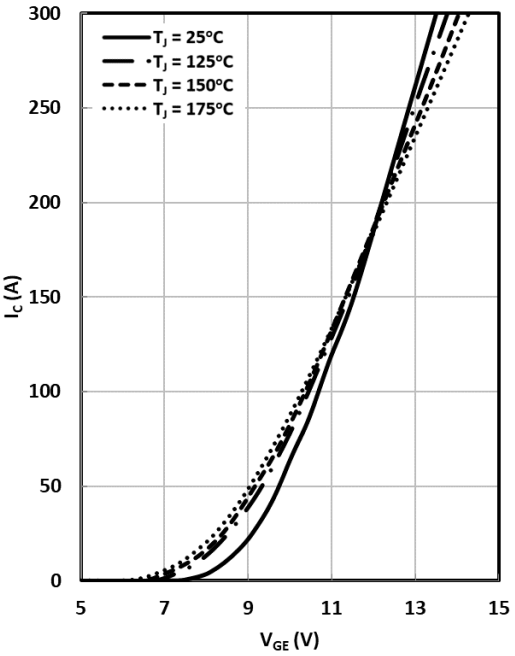


Fig. 2 IGBT (Inverter) Transfer Characteristics

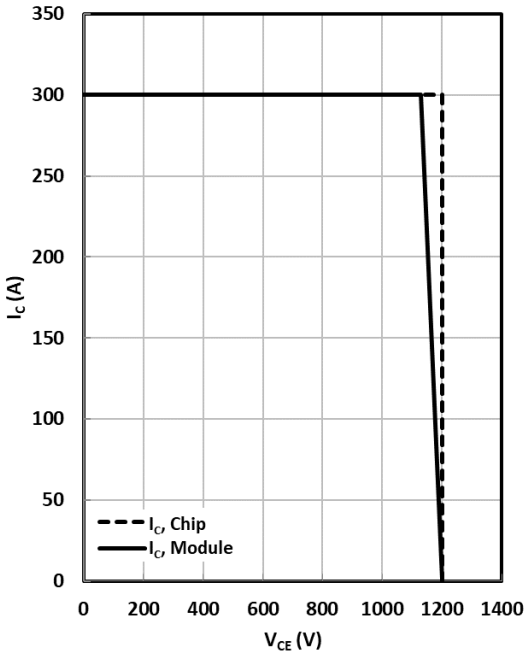


Fig. 3 RBSOA

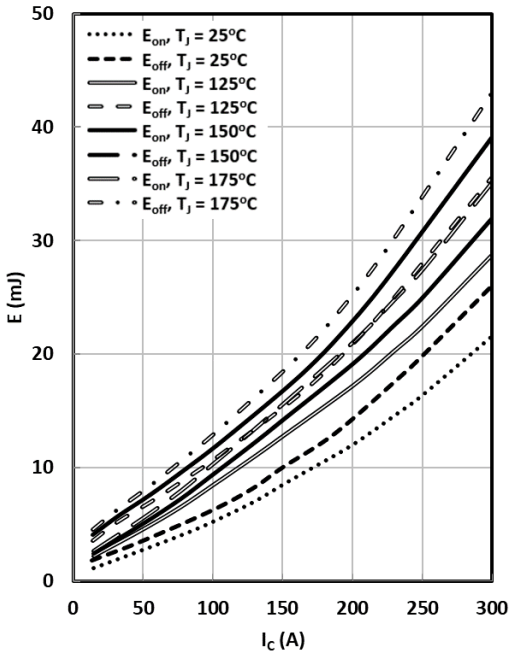


Fig. 4 IGBT Switching Loss VS. I_C

(V_{CC} = 600V, V_{GE} = ±15V, R_G = 5.1Ω)

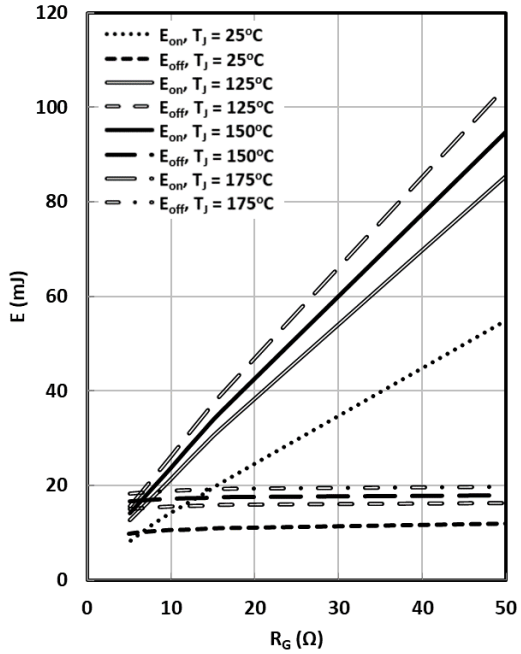


Fig. 5 IGBT Switching Loss VS. R_G

(V_{CC} = 600V, V_{GE} = ±15V, I_C = 150A)

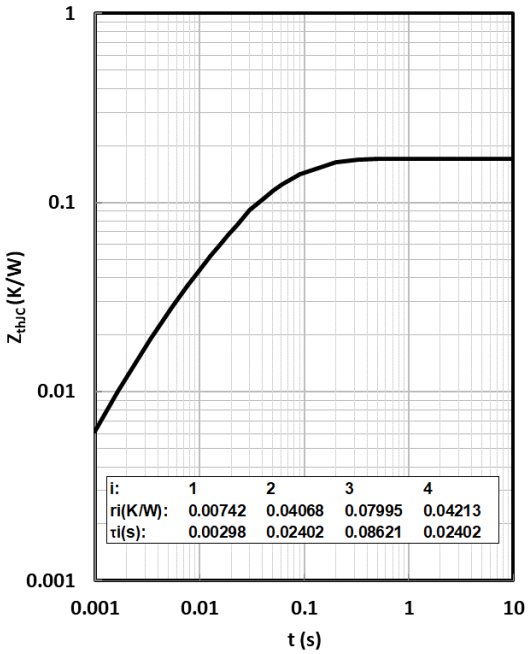


Fig. 6 IGBT (Inverter) Transient Thermal Impedance

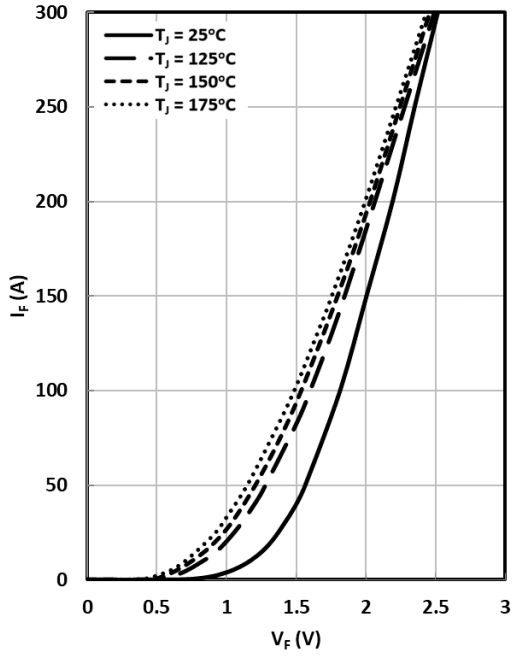


Fig. 7 Diode (Inverter) Forward Characteristics

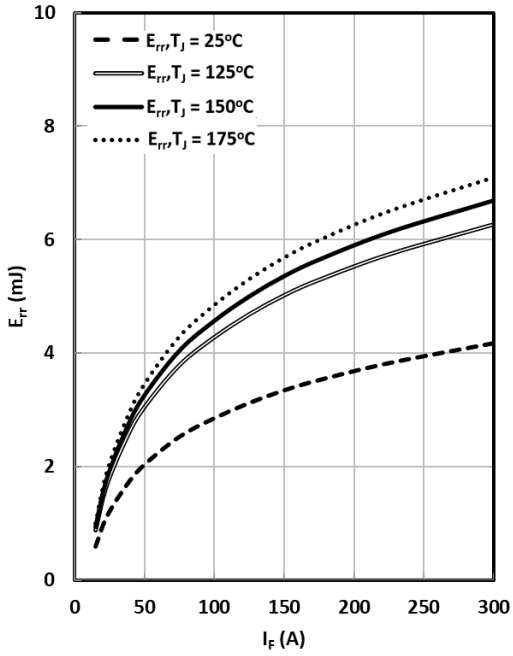


Fig. 8 Diode (Inverter) Switching Loss vs. I_F

(V_{CC} = 600V, R_G = 5.1Ω)

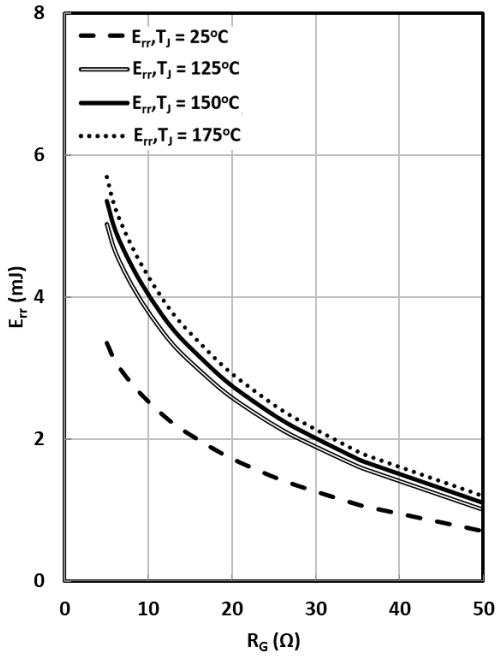


Fig. 9 Diode (Inverter) Switching Loss vs. R_G

(V_{CC} = 600V, I_F = 150A)

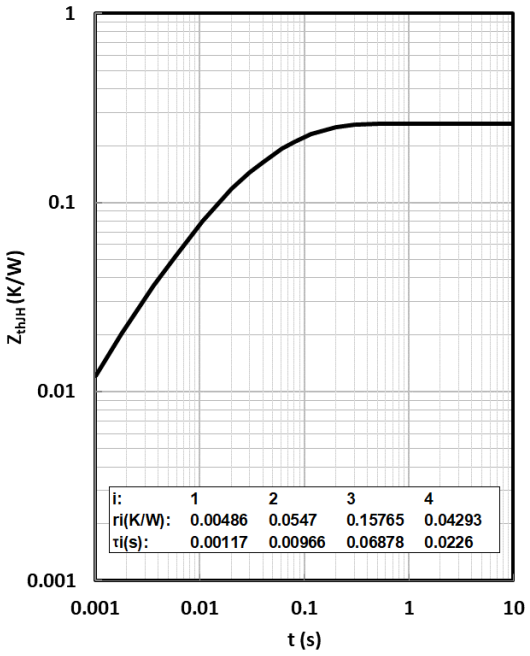


Fig. 10 Diode (Inverter) Transient Thermal Impedance

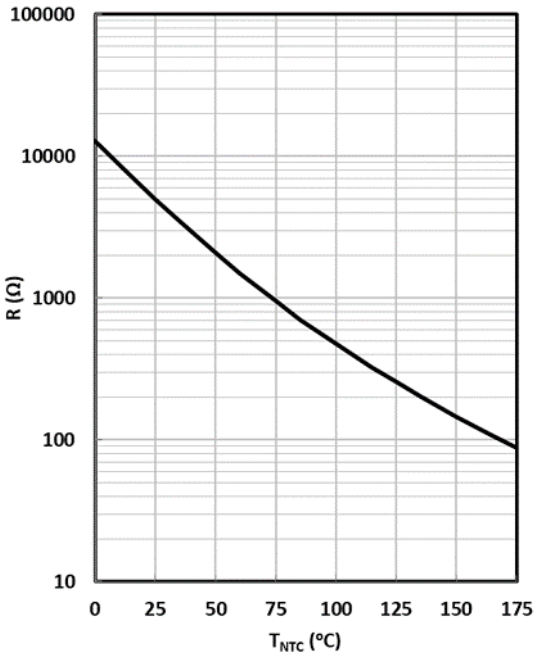
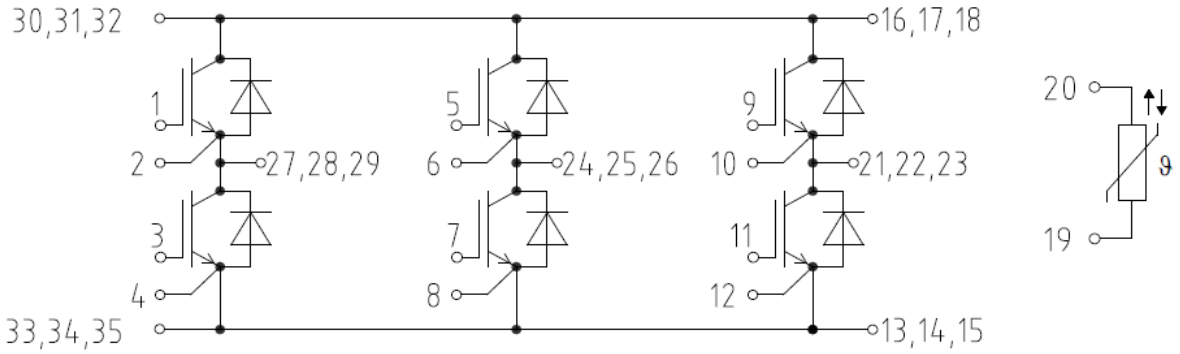
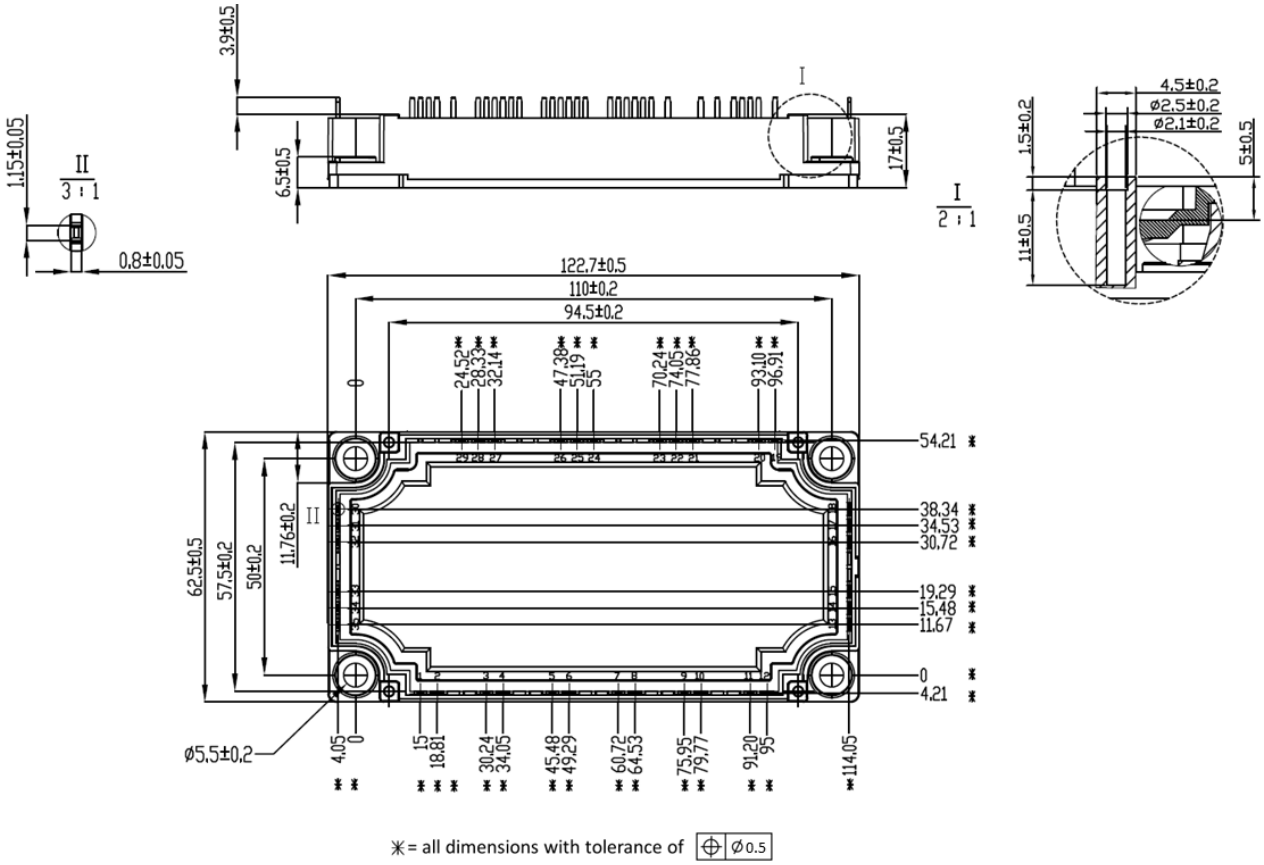


Fig. 11 NTC Temperature Characteristics

- **Circuit diagram**



- **Package Dimensions**



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